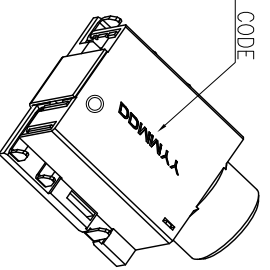
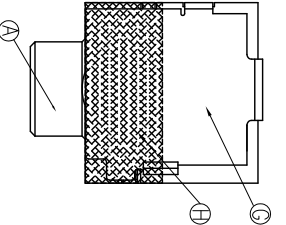


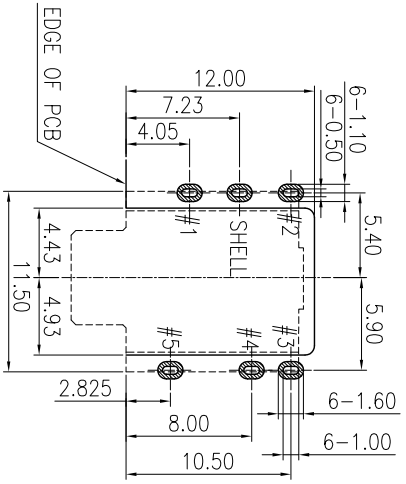
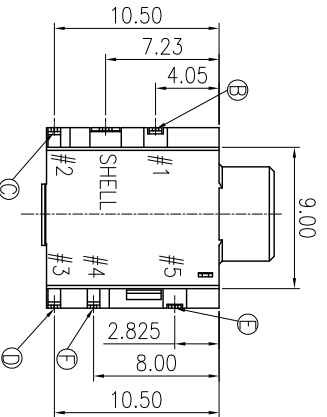
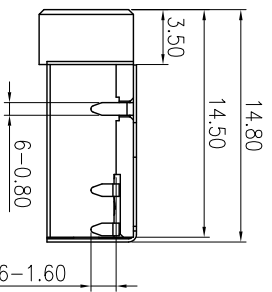
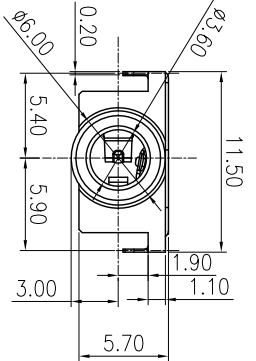
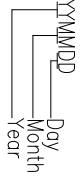
REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PRODUCTS RELEASE	Kim	2010.06.23
B	ECN:c120070 MODIFY PLATING	Longjiang	2012.03.15



DATE CODE

SPECIFICATIONS:

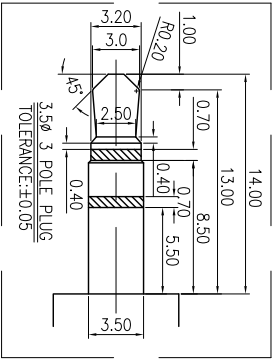
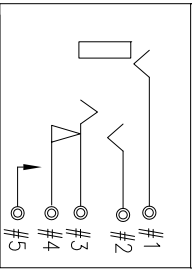
- 1. ELECTRICAL CHARACTERISTICS:**
- 1-1. RATING: 12V AC, 1A DC.
 - 1-2. CONTACT RESISTANCE: 50m Ω MAX.
 - 1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
 - 1-4. INSULATION RESISTANCE: 100M Ω MIN. MEASURED BY 500 VDC
- 2. MECHANICAL CHARACTERISTICS:**
- 2-1. INSERTION FORCE : 0.4~3.0 KGf
 - 2-2. WITHDRAWAL FORCE : 0.3~2.0 KGf
- 3. LIFE TEST: 5,000 CYCLES MIN.**
- 4. OTHER GENERAL SPEC. TO REFER "2SJ2318 SERIES SPEC".**
- 5. TO CONFORM TO THE SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.**
- 6. HALOGEN FREE PRODUCT IDENTIFICATION MARK ON JACK: Ⓞ**
- 7. HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING: Ⓞ**
- 8. FOR REFLOW SOLDERING LEAD-FREE PROCESS.**
- 9. DATE CODE: YYMMDD**



RECOMMENDED P.C.B. LAYOUT T=1.00

TOP VIEW (TOLERANCE: ±0.05)

SCHEMATIC



NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
A	BODY	1	UL 94V-0	BLACK
B	EARTH	1	COPPER ALLOY 0.20T	
C	RING	1	COPPER ALLOY 0.20T	Nickel plating/Δ
D	WAKE TERMINAL	1	COPPER ALLOY 0.20T	And Solder foil, oil over
E	TRANSFER TERMINAL	1	COPPER ALLOY 0.20T	Gold flush on Contact area
F	SHIELD	1	3M 347 0.10T	YELLOW COLOR
G	WTLAR	1	COPPER ALLOY 0.20T	NI PLATING

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: ANGLES:

X : ±0.5 X : ±2°
 X.X : ±0.3 X.X : ±1'
 X.XX : ±0.2

TITLE	3.50 PHONE JACK			
DWN	20120320	PART NO.	2SJ2322-000111	
CHKD	20120320	SCALE	1:1	
APVD	20120320	SIZE	A3	
		SHEET	10F1	
		REV.	B	

CUSTOMER COPY

Singatron Enterprise Co., Ltd.
 信音企業股份有限公司